

Solderability Profile

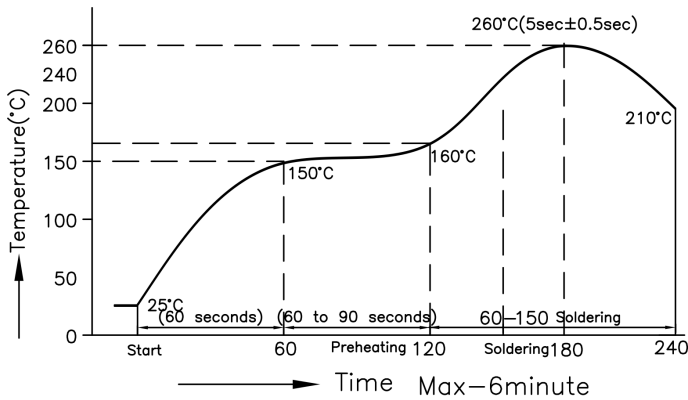


Sub = Nylon 6T Material Temperature Specification

Solder Regular Condition

Soldering Temperature : 260°C ±5°C
Time : 5 ±0.5 sec
Solder Wetting Percentage : 95% min

Reflow Condition



Nylon 6T Recommended Temperature Profile

Test Conditions

Solder Method : Reflow or Wave-Soldering
Environment : Room Air
Solder Composition : Soldering Paste
Test Board : 52mm × 36.5mm × 1.6mm thick

This temperature profile is based on the above condition. Individual applications the actual temperature may vary. Consult your solder paste and equipment Manufacture fro specific recommendations.

There must not be visible defect after testing.

